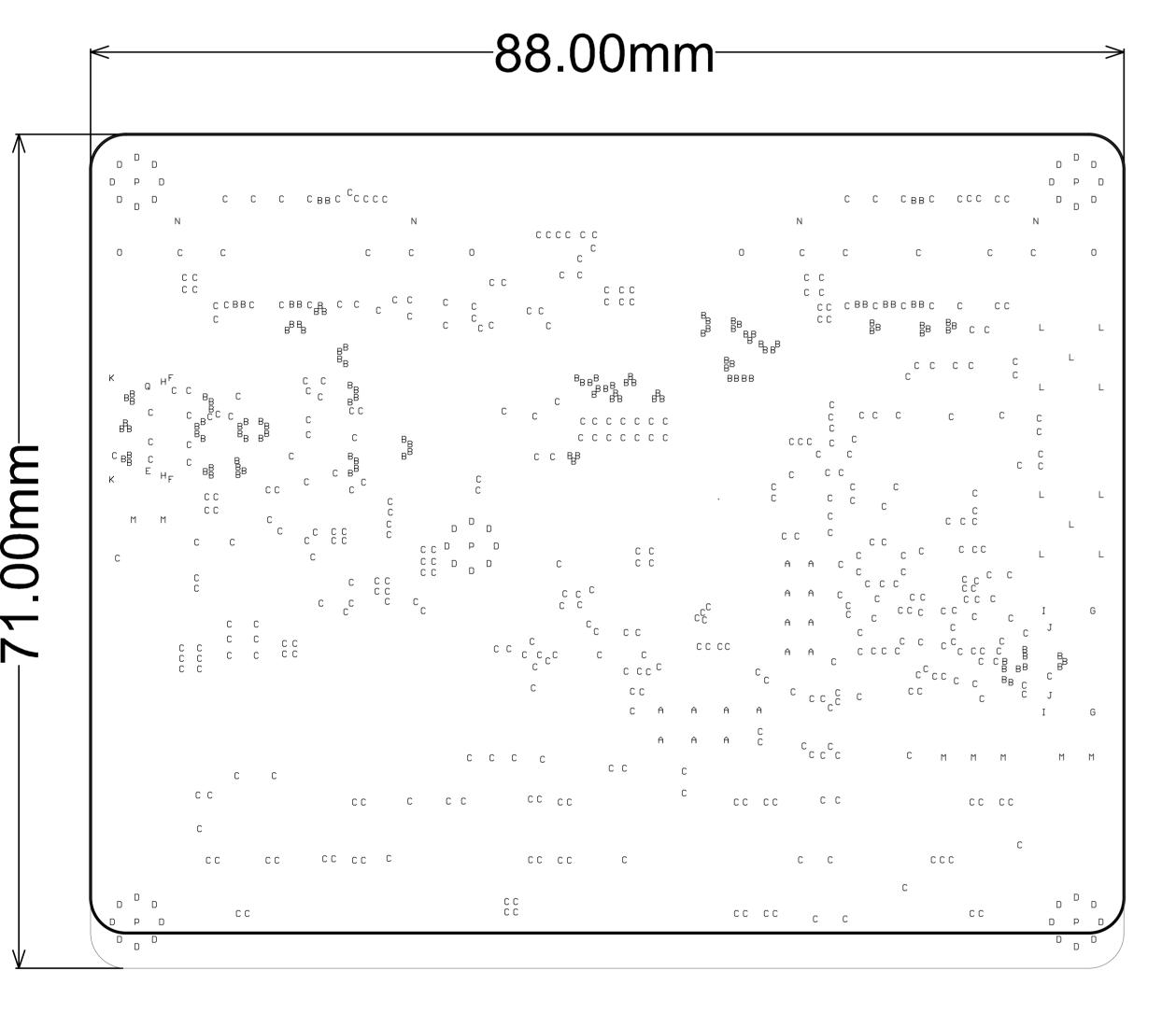
IMPEDANCE TABLE

LAYER	IMPE	DANCE		SPACE
	SINGLE END	DIFF	WIDTH	
L01 & L04	50 OHM		6 MILS	
L01 & L04		90 OHM	6 MILS	8 MILS
L01 & L04		100 OHM	5 MILS	8 MILS



DRILL DRAWING/NO BOTTOM PASTEMASK BOARD OUTLINE

FABRICATION NOTE NOTES: (UNLESS OTHERWISE SPECIFIED)

- 1. FABRICATE PER IPC-6012B TYPE 2 CLASS 3
- 2. MATERIAL: BASE MATERIAL: FR4 Tg 180
- 3. BOARD THICKNESS: 1.6MM +/- 10% TOL.
- 4. NO OF LAYERS: 04
- 5. SURFACE FINISH: ENIG FINISH, 1u Gold
- 6. SOLDERMASK CLEARANCE IS GIVEN SAME AS PAD SIZE EXCEPT FIDUCIALS.

 VENDOR SHALL MODIFY THE MASK CLEARANCE AS PER THE REQUIRED MANUFACTURING TOLERANCE

 COLOR: Matte Black
- 7. SILKSCREEN:DOUBLE SIDE WITH PERMANENT NON CONDUCTIVE WHITE EPOXY INK SILKSCREEN MAY BE TRIMMED OFF ANY SOLDERED ENTITY.
- 8. BOW AND TWIST NOT TO EXCEED 0.180MM (0.007") PER INCH AS MEASURED PER IPC-TM-650.
- 9. 100%CONTINUITY TESTING USING DATABASE NETLIST SHALL BE PERFORMED.
- 10. VENDOR SHOULD FOLLOW ROHS COMPLAINT PROCESS FOR MANUFACTURING.

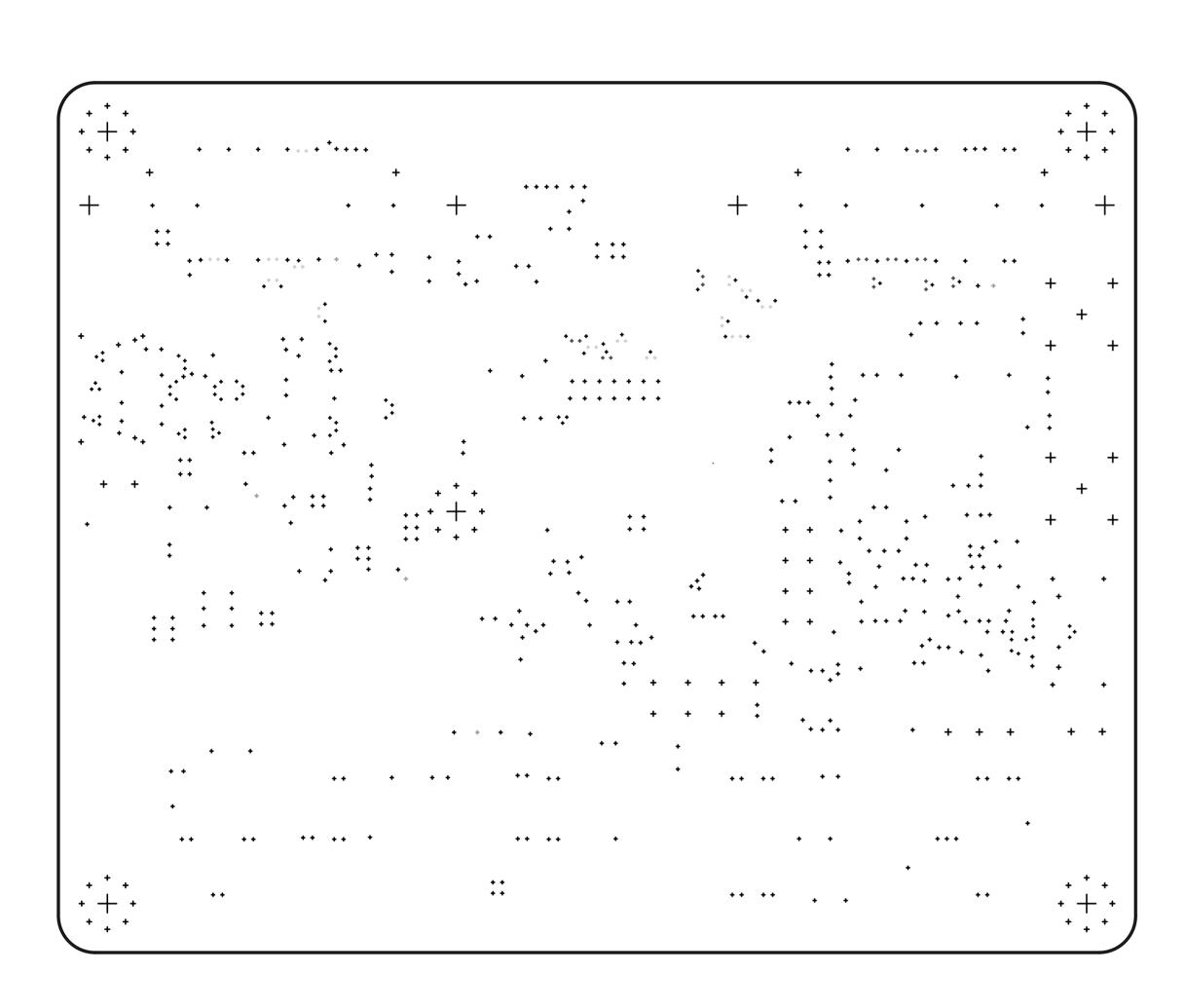
Layer	Name	Material	Thickness	Constant	Board Layer Stack
	Top Overlay				
	Top Solder	Solder Resist	0.80mil	3.5	
1	Top Layer		1.38mil		
	Dielectric 2	PP-006	3.94mil	4.05	
2	L2_GND	CF-004	0.69mil		
	Dielectric 1	Core-009	49.80mil	4.05	
3	L3_PWR	CF-004	0.69mil		
	Dielectric 3	PP-006	3.94mil	4.05	
4	Bottom Layer		1.38mil		
	Bottom Solder	Solder Resist	0.80mil	3.5	
	Bottom Overlay				

Total board thickness: 63.41mil

Symbol	Count	Hole Size	Plated	Hole Type	Drill Layer Pair
В	129	8.00mil (0.203mm)	PTH	Round	Top Layer - Bottom Layer
С	431	10.00mil (0.254mm)	PTH	Round	Top Layer - Bottom Layer
D	40	15.00mil (0.381mm)	PTH	Round	Top Layer - Bottom Layer
E	1	19.69mil (0.500mm)	NPTH	Slot	Top Layer - Bottom Layer
Н	2	23.62mil (0.600mm)	РТН	Slot	Top Layer - Bottom Layer
G	2	23.62mil (0.600mm)	PTH	Slot	Top Layer - Bottom Layer
I	2	23.62mil (0.600mm)	РТН	Slot	Top Layer - Bottom Layer
F	2	23.62mil (0.600mm)	РТН	Slot	Top Layer - Bottom Layer
Q	1	24.80mil (0.630mm)	NPTH	Round	Top Layer - Bottom Layer
J	2	26.00mil (0.660mm)	NPTH	Round	Top Layer - Bottom Layer
K	2	29.53mil (0.750mm)	РТН	Slot	Top Layer - Bottom Layer
A	15	31.50mil (0.800mm)	РТН	Round	Top Layer - Bottom Layer
M	7	39.37mil (1.000mm)	РТН	Round	Top Layer - Bottom Layer
N	4	40.16mil (1.020mm)	NPTH	Round	Top Layer - Bottom Layer
	10	60.63mil (1.540mm)	РТН	Round	Top Layer - Bottom Layer
0	4	118.11mil (3.000mm)	NPTH	Round	Top Layer - Bottom Layer
Р	5	118.11mil (3.000mm)	РТН	Round	Top Layer - Bottom Layer
	659 Total				tre position to tool and centre

Slot definitions: Routed Path Length = Calculated from tool start centre position to tool end centre position.

Hole Length = Routed Path Length + Tool Size = Slot length as defined in the PCB layout



DRILL GUIDE BOARD OUTLINE